

1A, 50V - 1000V High Efficient Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Glass passivated chip junction
- Ideal for automated placement
- Low forward voltage drop
- Ultrafast recovery time for high efficiency
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- DC to DC converter
- Automotive application
- Car lighting
- Snubber
- · Freewheeling application

MECHANICAL DATA

- Case: DO-214AC (SMA)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- · Polarity: Indicated by cathode band
- Weight: 0.060g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
I _F	1	Α		
V_{RRM}	50 - 1000	V		
I _{FSM}	30	Α		
T _{J MAX}	150	°C		
Package	DO-214AC (SMA)			
Configuration	Single die			









DO-214AC (SMA)



		116	116	116	116	He	116	116	
PARAMETER	SYMBOL	US 1AH	US 1BH	US 1DH	US 1GH	US 1JH	US 1KH	US 1MH	UNIT
Marking code on the device		US1A	US1B	US1D	US1G	US1J	US1K	US1M	
Repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Reverse voltage, total rms value	V _{R(RMS)}	35	70	140	280	420	560	700	V
Forward current	I _F	1			Α				
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	FSM 30				А			
Junction temperature	TJ	T _J - 55 to +150				°C			
Storage temperature	T _{STG}	- 55 to +150				°C			



THERMAL PERFORMANCE				
PARAMETER	SYMBOL	ТҮР	UNIT	
Junction-to-lead thermal resistance	$R_{\Theta JL}$	27	°C/W	
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	75	°C/W	

PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	US1AH US1BH US1DH US1GH	I _F = 1A, T _J = 25°C	V _F	-	1.0	V
	US1JH US1KH US1MH			-	1.7	V
D		$T_J = 25^{\circ}C$		-	5	μA
Reverse current @ rated V _R ⁽²⁾		T _J = 125°C	- I _R	-	150	μΑ
Junction capacitance US1E US1C US1G US1J US1K	US1AH US1BH US1DH US1GH	1MHz, V _R = 4.0V	CJ	15	-	pF
	US1JH US1KH US1MH			10	-	pF
Reverse recovery time	US1AH US1BH US1DH US1GH	$I_F = 0.5A, I_R = 1.0A,$ $I_{rr} = 0.25A$	t _{rr}	-	50	ns
	US1JH US1KH US1MH			-	75	ns

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING		
US1xH	DO-214AC (SMA)	7,500 / Tape & Reel		

Notes:

1. "x" defines voltage from 50V(US1AH) to 1000V(US1MH)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

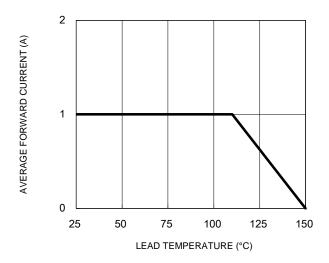


Fig.3 Typical Reverse Characteristics

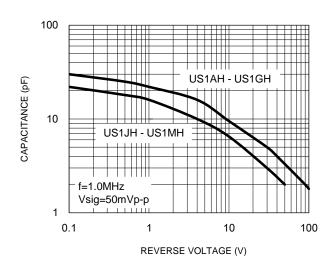
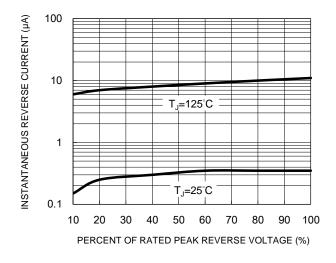


Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics



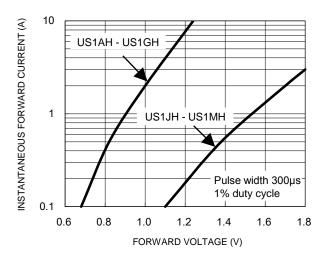
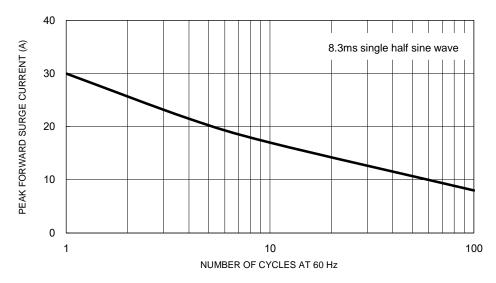


Fig.5 Maximum Non-Repetitive Forward Surge Current





CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.6 Typical Transient Thermal Characteristics

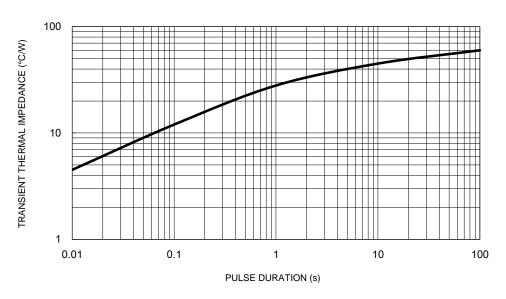
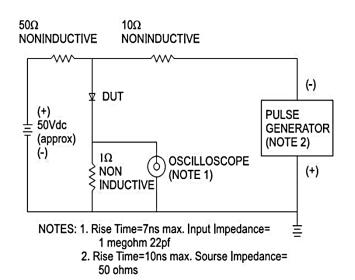
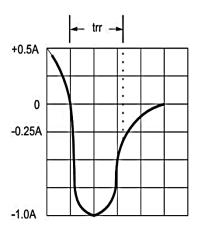


Fig.7 Reverse Recovery Time Characteristic And Test Circuit Diagram

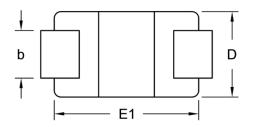


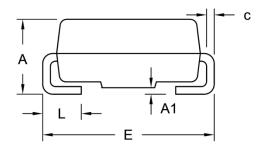




PACKAGE OUTLINE DIMENSIONS

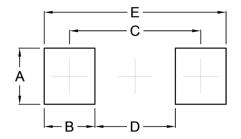
DO-214AC (SMA)





DIM.	Unit (mm)		Unit (inch)	
Dilvi.	Min.	Max.	Min.	Max.
Α	1.99	2.50	0.078	0.098
A1	0.10	0.20	0.004	0.008
b	1.27	1.58	0.050	0.062
С	0.15	0.31	0.006	0.012
D	2.29	2.83	0.090	0.111
E	4.95	5.33	0.195	0.210
E1	4.06	4.60	0.160	0.181
L	0.90	1.41	0.035	0.056

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	1.68	0.066
В	1.52	0.060
С	3.93	0.155
D	2.41	0.095
E	5.45	0.215

MARKING DIAGRAM



= Marking Code P/N G = Green Compound

= Date Code ΥW F = Factory Code



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